

(1,27mm) .050"

DWM, HDWM SERIES



MICRO BOARD STACKER

SPECIFICATIONS

DWM

For complete specifications see www.samtec.com?DWM

Insulator Material:

Top: Black LCP
Bottom: Natural LCP

Terminal Material:

Phosphor Bronze

Plating:

Au or Sn over

50µ" (1,27µm) Ni

Current Rating:

1A

Operating Temp Range:

-55°C to + 105°C with Tin

-55°C to + 125°C with Gold

RoHS Compliant:

Yes

HDWM

For complete specifications see www.samtec.com?HDWM

Same as DWM except not CSA rated.

Processing:

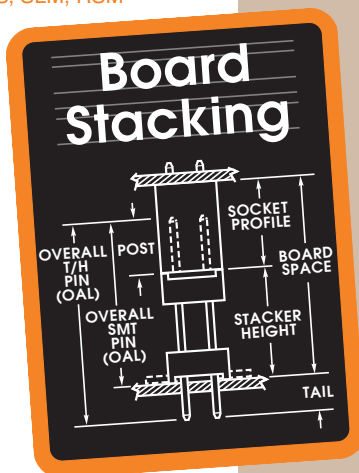
Lead-Free Solderable:

Yes

SMT Lead Coplanarity:

(0,15mm) .006" max

Mates with:
SMS, SLM, RSM



Variable stacker height

Ideal for high density "skyscraper" board stacking

Choice of Surface mount or Through-hole

TYPE STRIP	NO. PINS PER ROW	LEAD STYLE	PLATING OPTION	ROW OPTION	STACKER HEIGHT	OTHER OPTION
	01 thru 50	Specify LEAD STYLE from chart	-L = 10µ" (0,25µm) Gold contact, Matte Tin on tail -G = 10µ" (0,25µm) Gold on post, Gold flash on tail	-S = Single Row -D = Double Row	"XXX" = Stacker Height Example: -250 = (6,35mm) .250"	"XXX" = Polarized Position (Specify position of omitted pin) -SM = Surface Mount (Requires HDWM. 02 thru 40 positions only.) -A = Alignment Pin (Requires HDWM. 6 positions min -D only.) Metal or plastic at Samtec discretion (N/A with -LC) -LC = Locking Clip (Requires HDWM. (5 positions min. -D only) (N/A with -A) (Manual placement required) -P = Pick & Place Pad (Requires HDWM)
	DWM = Standard Board Spacer HDWM = High Temp Board Spacer					

Note: Other Gold plating options available. Contact Samtec.

Note: These Series are non-standard, non-returnable.

Due to technical progress, all designs, specifications and components are subject to change without notice.

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